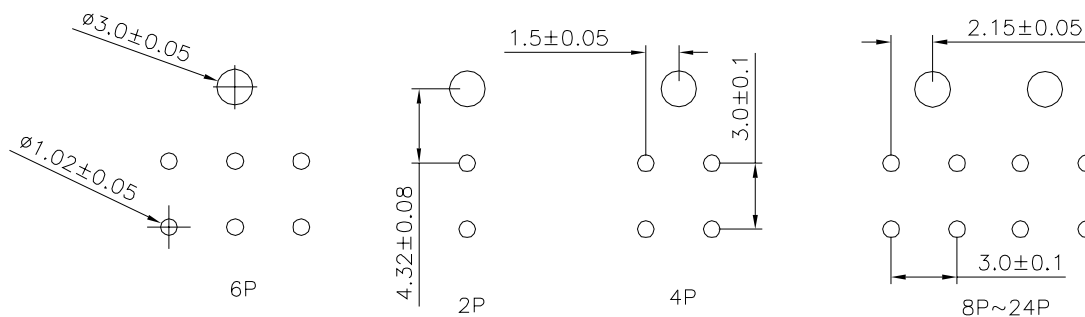


**△ SPECIFICATION****1.General Characteristics**

3.0mm Micro-Fit Wafer 2XXX DIP 90° With Post Black
Insulator Withstand Tin Plated Withstand High Temperature

2.Material&Finish

Insulator:LCP,Black
Contact:Brass,Tin Plated

3.Electrical Characteristics

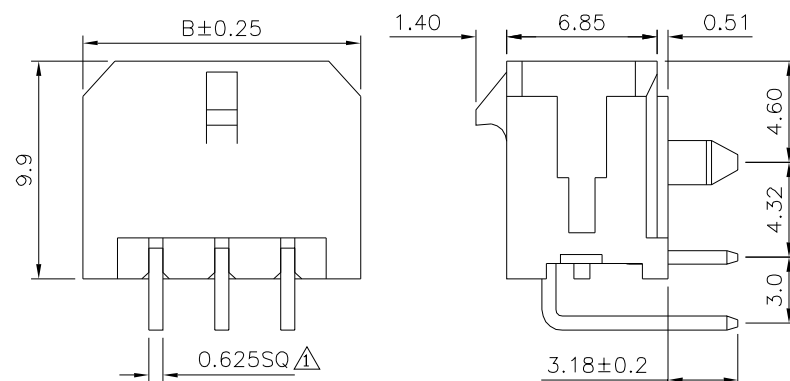
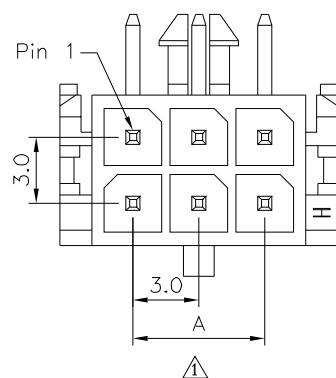
Current Rating:

Wire Size	#20	#22	#24	#26	#28	#30
Amp	5A	5A	4A	3A	2A	1A

Voltage Rating:250V AC(RMS) Or DC
Contact Resistance:10 Milliohms Max.
Dielectric Strength:1500V AC/Minute

4.Environmental Characteristics

Ambient Temperature Range: $-40^{\circ}\text{C} \sim +105^{\circ}\text{C}$
(Including Temperature Rise)

5.RoHS Compliant

Pin	A	B
02	—	6.65
04	3.0	9.65
06	6.0	12.65
08	9.0	15.65
10	12.0	18.65
12	15.0	21.65
14	18.0	24.65
16	21.0	27.65
18	24.0	30.65
20	27.0	33.65
22	30.0	36.65
24	33.0	39.65

4UCON 元化興業股份有限公司
4UCON TECHNOLOGY INC.

DRAWING No.

07789

SCALE

NONE

APPROVED BY

MEI

CHECKED BY

HZF

DRAWING BY

CYP

REV.

B1

UNLESS OTHERWISE
SPECIFIED
TOLERANCES ARE

 $.X \pm 0.25$ $.XX \pm 0.15$ $.XXX \pm 0.05$ UNIT
mm

△ B1

Modify Data

HZF

01/06/2018

△ B0

NEW RELEASE

HZF

01/19/2009

NO. REV.

REVISIONS

CHK

DATE